

Materials Declaration Form

| IPC Form Type * | 1752 Distribute | Version | 2 |
|--------------------|--------------------|-----------------|--------------------|
| Sectionals * | Material Info | Subsectionals * | A-D |
| | Manufacturing Info | | * : Required Field |

| Supplier Information | | | | | | | | |
|-----------------------------|---------------------------------------|------------------------|-----------------------------------|--|--|--|--|--|
| Company Name * | STMicroelectronics | Response Date * | 2016-03-23 | | | | | |
| Contact Name * | Refer to Supplier Comment section | | Refer to Supplier Comment section | | | | | |
| Authorized Representative * | Rossana Bonaccorso | Representative Title | IPD MD Champion | | | | | |
| Representative Phone * | Refer to Supplier Comment section | Representative Email * | Refer to Supplier Comment section | | | | | |
| Sunnlier Comment | Online Technical Support - STMicroele | | | | | | | |

Uncertainty Statement

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Legal Statement

Supplier Acceptance * true Legal Declaration * Standard

Legal Statement

Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as omprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

| Product | | | | | | | | | |
|-----------------|---------------|---------|---------------|------------------|--|--|--|--|--|
| Mfr Item Number | Mfr Item Name | Version | Mfr Site | Date | | | | | |
| SM30T23AY | AHZH*TYU023M | А | BOUSKOURA B/E | 2016-03-23 | | | | | |
| | Amount | UoM | Unit type | ST ECOPACK Grade | | | | | |
| | 250.00 | mg | Each | ECOPACK2 | | | | | |

| Manufacturing information | | | | | | | | |
|---------------------------|---------------------|----------------------|---------|----------------|--|--|--|--|
| J-STD-020 MSL Rating | Classification Temp | Nbr of Reflow Cycles | | | | | | |
| 1 | 260 | 3 | | | | | | |
| bulk Solder Termination | Terminal Plating | Terminal Base Alloy | Comment | life.augmented | | | | |
| NAC | Tin (Sn), matte | Copper Alloy | | meradginenied | | | | |

| Package Designator | Size | Nbr of instances | Shape | |
|--------------------|-------------------|------------------|--------|--|
| SOJ | 6.69-5.63-2.38 | 2 | J BEND | |
| Comment | SMC CLIP (SOD 15) | | | |

| | Query | Response | | | | | |
|---|---------------------------|----------|--|--|--|--|--|
| . , | | | | | | | |
| 1 - Product(s) meets EU RoHS requireme | nt without any exemptions | false | | | | | |
| 2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may | | | | | | | |
| apply) | | | | | | | |
| 3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s) true | | | | | | | |
| 4 - Product(s) does not meet EU RoHS requirements and is not under exemptions | | | | | | | |
| 5 - Product(s) is obsolete, no information is available false | | | | | | | |
| 6 - Product(s) is unknown, no information is available | | | | | | | |
| Exemption Id. | Exemption Id. Description | | | | | | |
| 7a Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead) | | | | | | | |

| QueryList: REACH-17th December 2015 | | | | | | | | |
|--|--|--|--|--|--|--|--|--|
| Query Response | | | | | | | | |
| 1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH | | | | | | | | |
| CategoryLevel_Name CategoryLevel_Threshold amount in product (mg) Application | | | | | | | | |
| | | | | | | | | |

| Material Composition Declarat | laterial Composition Declaration | | | | | Mfr Item Name | AHZH*1 | YU023M | | | | |
|-------------------------------|----------------------------------|---------|-----|----------|-------------------------|----------------------|-------------|--------------------|--------|-----|---|--------------------------------|
| Homogeneous Material | Material Group | Mass | UoM | Level | Substance Category | Substance | CAS | Exempt | Mass | UoM | Concentration in homogeneous material (ppm) | Concentration in product (ppm) |
| Die | Other inorganic materials | 9.344 | mg | supplier | die | Silicon (Si) | 7440-21-3 | | 9.059 | mg | 969499 | 36236 |
| | | | | supplier | metallization | Aluminium (Al) | 7429-90-5 | | 0.052 | mg | 5565 | 208 |
| | | | | supplier | metallization | Nickel (Ni) | 7440-02-0 | | 0.038 | mg | 4067 | 152 |
| | | | | supplier | metallization | Gold (Au) | 7440-57-5 | | 0.038 | mg | 4067 | 152 |
| | | | | supplier | Passivation | Silicon Oxide | 7631-86-9 | | 0.052 | mg | 5565 | 208 |
| | | | | supplier | back side metallization | Aluminium (Al) | 7429-90-5 | | 0.035 | mg | 3746 | 140 |
| | | | | supplier | back side metallization | Gold (Au) | 7440-57-5 | | 0.012 | mg | 1284 | 48 |
| | | | | supplier | back side metallization | Nickel (Ni) | 7440-02-0 | | 0.058 | mg | 6207 | 232 |
| Leadframe | Copper & its alloys | 79.541 | mg | supplier | alloy | Copper (Cu) | 7440-50-8 | | 78.669 | mg | 989037 | 314676 |
| | | | | supplier | alloy | Iron (Fe) | 7439-89-6 | | 0.079 | mg | 993 | 316 |
| | | | | supplier | alloy | Iron Phosphide (FeP) | 26508-33-8 | | 0.024 | mg | 302 | 96 |
| | | | | supplier | metallization | Nickel (Ni) | 7440-02-0 | | 0.769 | mg | 9668 | 3076 |
| Soft solder | Solder | 7.920 | mg | JIG - R | solder | Lead (Pb) | 7439-92-1 | 7a-Lead in high me | 7.405 | mg | 934975 | 29620 |
| | | | | supplier | solder | Tin (Sn) | 7440-31-5 | | 0.396 | mg | 50000 | 1584 |
| | | | | supplier | solder | Silver (Ag) | 7440-22-4 | | 0.119 | mg | 15025 | 476 |
| Encapsulation | Other Organic Materials | 111.709 | mg | supplier | mold compound | Silica, vitreous | 60676-86-0 | | 84.899 | mg | 760002 | 339596 |
| | | | | supplier | mold compound | Epoxy Cresol Novolak | 29690-82-2 | | 11.394 | mg | 101997 | 45576 |
| | | | | supplier | mold compound | Phenol resin | 9003-35-4 | | 6.703 | mg | 60004 | 26812 |
| | | | | supplier | mold compound | Others | Proprietary | | 5.585 | mg | 49996 | 22340 |
| | | | | supplier | mold compound | Metal hydroxide | 21645-51-2 | | 2.234 | mg | 19998 | 8936 |
| | | | | supplier | mold compound | Carbon black | 1333-86-4 | | 0.894 | mg | 8003 | 3576 |
| Connections coating | Solder | 1.972 | mg | supplier | solder alloy | Tin (Sn) | 7440-31-5 | | 1.972 | mg | 1000000 | 7888 |
| Clip | Copper & its alloys | 39.514 | mg | supplier | alloy | Copper (Cu) | 7440-50-8 | | 39.514 | mg | 1000000 | 158056 |